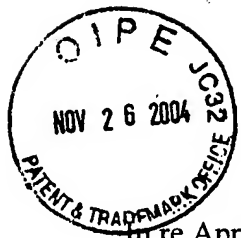


TFW

Attorney Docket No.: H1881



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Connie Pin-Chin Wang, et al.

Serial No.: 10/665,938

Filed: September 17, 2003

Title: SEMICONDUCTOR COMPONENT AND METHOD OF MANUFACTURE

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Group Art Unit: 2818

Examiner: Phuc T. Dang

RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This correspondence is in response to the Office action mailed November 12, 2004.



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: :
Connie Pin-Chin Wang, et al. : Group Art Unit: 2818
Application No.: 10/665,938 : Examiner: Phuc T. Dang
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Alexandria, VA 22313-1450

RESPONSE TO RESTRICTION REQUIREMENT TRANSMITTAL

1. Transmitted herewith is a Response to Restriction Requirement for this application.
2. Applicant believes there are no additional fees required for these filings. The Commissioner is hereby authorized to charge any deficiency to Deposit Account No. 50-2173. A duplicate copy of this Transmittal Letter is enclosed.

Respectfully submitted,

Dated: 22 November 2004

Rennie William Dover
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Phoenix, Arizona 85004
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CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this document (and any as referred to as being attached or enclosed) is being deposited with sufficient postage as first class mail with the United States Postal Service on November 22, 2004 and addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

CAVPHXDB:1131694.1